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U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

PRELIMINARY AMENDMENT

Docket Number:
52433/544

International Application
Number

PCT/JP97/02988

International Filing Date

August 27, 1997

U.S. Filing Date

Herewith

Examiner

Art Unit

8/19/99

Invention Title

**METHOD OF PARTIALLY PLATING SUBSTRATE FOR
ELECTRONIC DEVICES**

Inventor(s)

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Assistant Commissioner for Patents
Washington D.C. 20231
Box PCT

SIR:

Please amend the above-referenced patent application as follows:

In the Claims:

In claim 5, line 2, delete "~~or 2~~";

In claim 6, line 2, delete "~~or 2~~";

In claim 7, line 2, delete "~~or 2~~";

In claim 8, line 2, delete "~~or 2~~";

In claim 9, line 2, delete "~~or 2~~";


Remarks

The specification has been amended in order to eliminate multiple dependent claims.

An early indication of allowable subject matter is respectfully requested.

The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 11-0600. Duplicate copies of this sheet are enclosed herewith.

Dated: Feb 25/1999


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